

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3165374

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HANSPETER KATZ	11/25/2014
JOCHEN ARTMANN	11/25/2014
ERIC WOLF	11/25/2014
CHRISTIAN RAPP	11/25/2014
ULRICH KOEGER	11/25/2014
RECEIVING PARTY DATA	
Name:	TESAT-SPACECOM GMBH & CO. KG
Street Address:	GERBERSTRASSE 49
City:	BACKNANG
State/Country:	GERMANY
Postal Code:	71522
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14551680
CORRESPONDENCE DATA	
Fax Number:	(202)628-8844
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2026242500
Email:	ggoodin@crowell.com
Correspondent Name:	CROWELL & MORING LLP
Address Line 1:	1001 PENNSYLVANIA AVENUE, NW
Address Line 4:	WASHINGTON, D.C. 20004-2595
ATTORNEY DOCKET NUMBER:	108424.67143US
NAME OF SUBMITTER:	STEPHEN W. PALAN
SIGNATURE:	/Stephen W. Palan, Reg. No. 43,420/
DATE SIGNED:	12/30/2014
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 5	
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PATENT

REEL: 034600 FRAME: 0219

ASSIGNMENT AND DECLARATION UNDER 37 C.F.R. § 1.63
(For Use with Signed Application Data Sheet)

Title of Invention: Circuit Board With Ceramic Inlays

This assignment and declaration are directed to (check one):

- ☒ the application identified above by the attorney docket no. and title of invention
☐ PCT International Application Number _____, filed _____
☐ United States Application No. _____, filed _____

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, as a below-named inventor I have sold and assigned, and by these presents hereby sell and assign, unto:

Name of Assignee: Tesat-Spacecom GmbH & Co. KG

Address of Assignee: Gerberstrasse 49, 71522 Backnang, GERMANY

(hereinafter ASSIGNEE) all my right, title, and interest for the United States, its territories, and possessions in and to the above-identified invention and United States patent application, including any and all divisions or continuations thereof, and in and to any and all Letters Patent of the United States that may issue on any such application or for said invention, including any and all reissues or extensions thereof, to be held and enjoyed by said ASSIGNEE, its successors, or assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by me had this Assignment not been made.

I hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue any and all such Letters Patent to said ASSIGNEE, its successors, or assigns in accordance herewith.

I warrant and covenant that I have the full and unencumbered right to sell and assign the interests herein sold and assigned and that I have not executed and will not execute any document or instrument in conflict herewith.

I further covenant and agree that I will communicate to said ASSIGNEE, its successors, legal representatives, or assigns all information known to me relating to said invention or patent application and that I will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings, and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives, or assigns to perfect title to said invention, to said application including divisions and continuations thereof and to any and all Letters Patent that may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns, or to assist said ASSIGNEE, its successors, legal representatives, or assigns in obtaining, reissuing, or enforcing Letters Patent of the United States for said invention.

DECLARATION

As a below named inventor, I hereby declare that:

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Signature: _____

Inventor: _____

Hanspeter KATZ

25.11.14
DATE

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Signature:

Inventor:

Jochen ARTMANN

DATE

November 25, 2014

ASSIGNMENT AND DECLARATION UNDER 37 C.F.R. § 1.63
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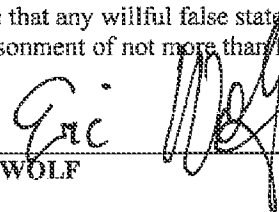
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Signature:

Inventor:


Eric WOLF

25.11.14
DATE

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Signature:
Inventor:Christian Rapp
Christian RAPP25-11-2014
DATE

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Signature:

Inventor:


Ulrich KOEGER25.11.2014
DATE